Interlink Electronics
FSR™Force Sensing Resistors™

Integration Guide

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1.0 Introduction

1.1 Our Background

Launched in 1985, Interlink Electronics is the world's leading innovator of cost effective polymeric force sensors. Our R&D team has developed a spectrum of technologies for "touch" and user interfaces solutions, and machine process controls. Today, with over 20 years of industry-leading experience, Interlink Electronics continues to innovate by designing and manufacturing sensors for a full range of applications such as industrial, military, consumer electronics, mobile, medical, and pointing devices.

One of the first uses of our patented thin film Force Sensing Resistor® (FSR) technology was in electronic drums and other musical instruments. Mobile phones, portable media players, navigation devices, handheld gaming, digital cameras, and other portable electronics are just a handful of devices that use our FSR technology. Customers that have used our sensor solutions include: Motorola, Samsung, Sony, LG, Varian, and Microsoft.

Serving a global customer base from offices in the U.S., Japan, and Korea, Interlink Electronics continues to expand with a proven track record of breakthrough technology and customer service. With a rich and diverse product history, we have established ourselves as a clear business and technology leader in a wide range of markets and are currently reshaping how organizations connect with their customers.

1.2 Intellectual Property and Other Legal Matters

Interlink Electronics holds several domestic and international patents for its Force Sensing Resistor technology. FSR and Force Sensing Resistor are our trademarks. All other trademarks are the property of their respective owners.

The product information contained in this document provides general information and guidelines only and must not be used as an implied contract with Interlink Electronics. Acknowledging our policy of continual product development, we reserve the right to change, without notice, any detail in this publication. Since Interlink Electronics has no control over the conditions and method of use of our products, we suggest that any potential user confirm their suitability for their own application.

2.0 Theory of Operation

The most basic FSR consists of two membranes separated by a thin air gap. The air gap is maintained by a spacer around the edges and by the rigidity of the two membranes. One of the membranes has two sets of interdigitated fingers that are electrically distinct, with each set connecting to one trace on a tail. The other membrane is coated with FSR ink. When pressed, the FSR ink shorts the two traces together with a resistance that depends on applied force.
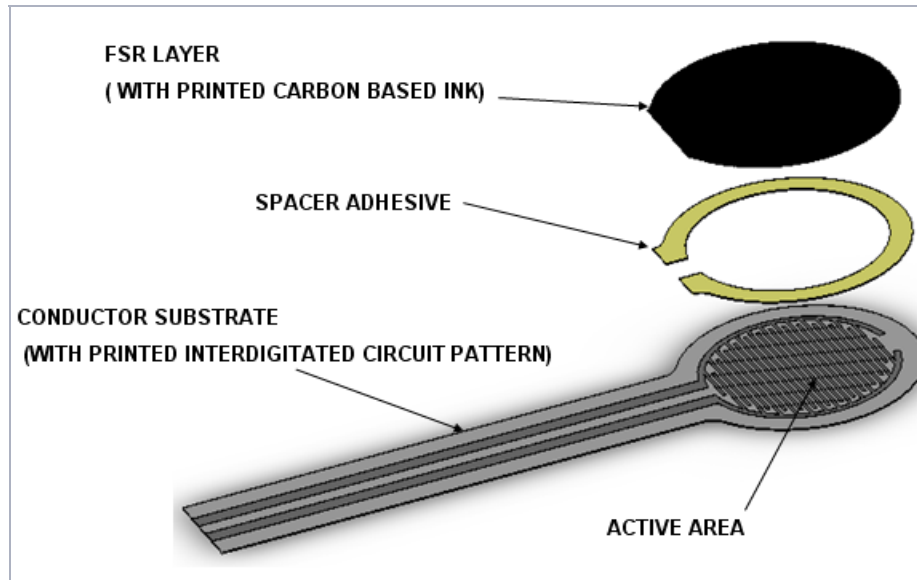

Figure 1: Basic FSR Construction

2.1 Basic Construction

Around the perimeter of the sensor is a spacer adhesive that serves both to separate the two substrates and hold the sensor together. This spacer typically has a thickness between 0.03mm and 0.1mm. This spacer may be screen printed of a pressure sensitive adhesive, may be cut from a film pressure sensitive adhesive, or may be built up using any combination of materials that can both separate and adhere to the two substrates.

Both membranes are typically formed on flexible polymer sheets such as PET, polyimide, or any other film material. In custom force sensors, the top substrate could be made with a slightly less flexible material, such as polycarbonate, thin metal or very thin circuit board material, as long as it is sufficiently deformable to allow a reasonable force to push the top substrate against the bottom substrate to activate the sensor.

The inside surface of one substrate is coated with FSR™ carbon-based ink. Figure 2 shows FSR ink under a microscope. When the two substrates are pressed together, the microscopic protrusions on the FSR ink surface short across the interdigitated fingers of the facing surface. At low forces only the tallest protrusions make contact. At higher forces more and more points make contact. The result is that the resistance between the conducting fingers is inversely proportional to the applied force.
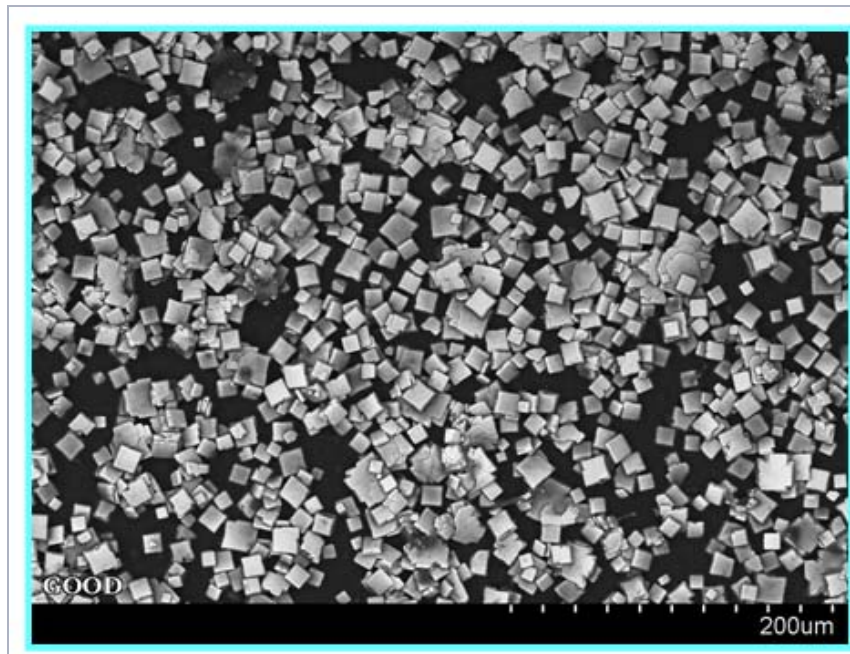
Figure 2: FSR Ink Micrograph

The conductive traces are typically screen printed from silver polymer thick film ink. However, these traces may also be formed out of gold plated copper as on flexible or standard circuit boards (FPC or PCB).

Force may be applied to either substrate. One of the exterior surfaces typically includes a mounting adhesive layer to allow mounting to a clean, smooth, rigid surface.

2.2 Force Curve

A typical resistance vs. force curve is shown in Figure 3. For interpretational convenience, the data is plotted on logarithmic scales. This particular force-resistance curve was measured from a model 402 sensor (12.7 mm diameter circular active area). A silicone rubber actuator with a 4 mm spherical radius tip and 60 Shore A durometer was used to press on the FSR).

The "actuation force" or turn-on threshold is typically defined as the force required to bring the sensor from open circuit to below 100kΩ resistance. This force is influenced by the substrate and overlay thickness and flexibility, size and shape of the actuator, and spacer-adhesive thickness (the size of the internal air gap between membranes).
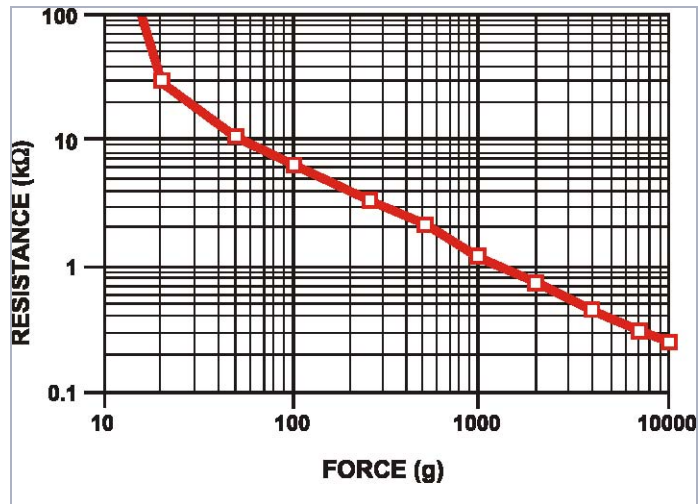
**Figure 3: Resistance vs. Force**

Immediately after turn-on, the resistance decreases very rapidly. At slightly higher and then intermediate forces, the resistance follows an inverse power law. At the high forces the response eventually saturates to a point where increases in force yield little or no decrease in resistance. Saturation can be pushed higher by spreading the applied force over a larger actuator.

3.0 FSR™ Force Sensing Resistor™ Products

Interlink designs and manufactures a broad array of sensor types. The basic FSR described above may be made in almost any shape or size and can even be made to detect position in addition to force. All of these products may be combined into arrays.

Single Zone
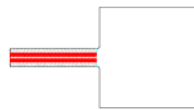
Single zone sensors can be made in a variety of shapes and sizes. Interlink provides both custom sensors and a standard catalog of round, square, and strip shaped single zone parts.
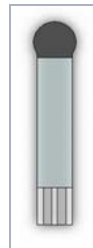
3.1 Standard vs. Custom

Standard

Standard FSRs deliver the most cost competitive solutions for a wide variety of applications. Cost savings are primarily achieved through reductions in tooling and engineering labor costs. The Interlink catalog of standard single zone FSRs is comprised of round, square, and strip sized sensors.

PART TYPE	DESCRIPTION	PART IMAGE
Model 400	FSR, 0.2" [5mm] Circle	
Model 402	FSR, 0.5" [12.7mm] Circle	
Model 406	FSR,1.5" [38.1mm] Square	
Model 408	FSR, 24" [609.6mm] Strip	

Round

Standard round FSRs are offered in both Model 400 (Figure 5) and Model 402 (Figure 6) standard models. They are common and versatile products that can be incorporated into a variety of devices.

Measurements: millimeters [inches]
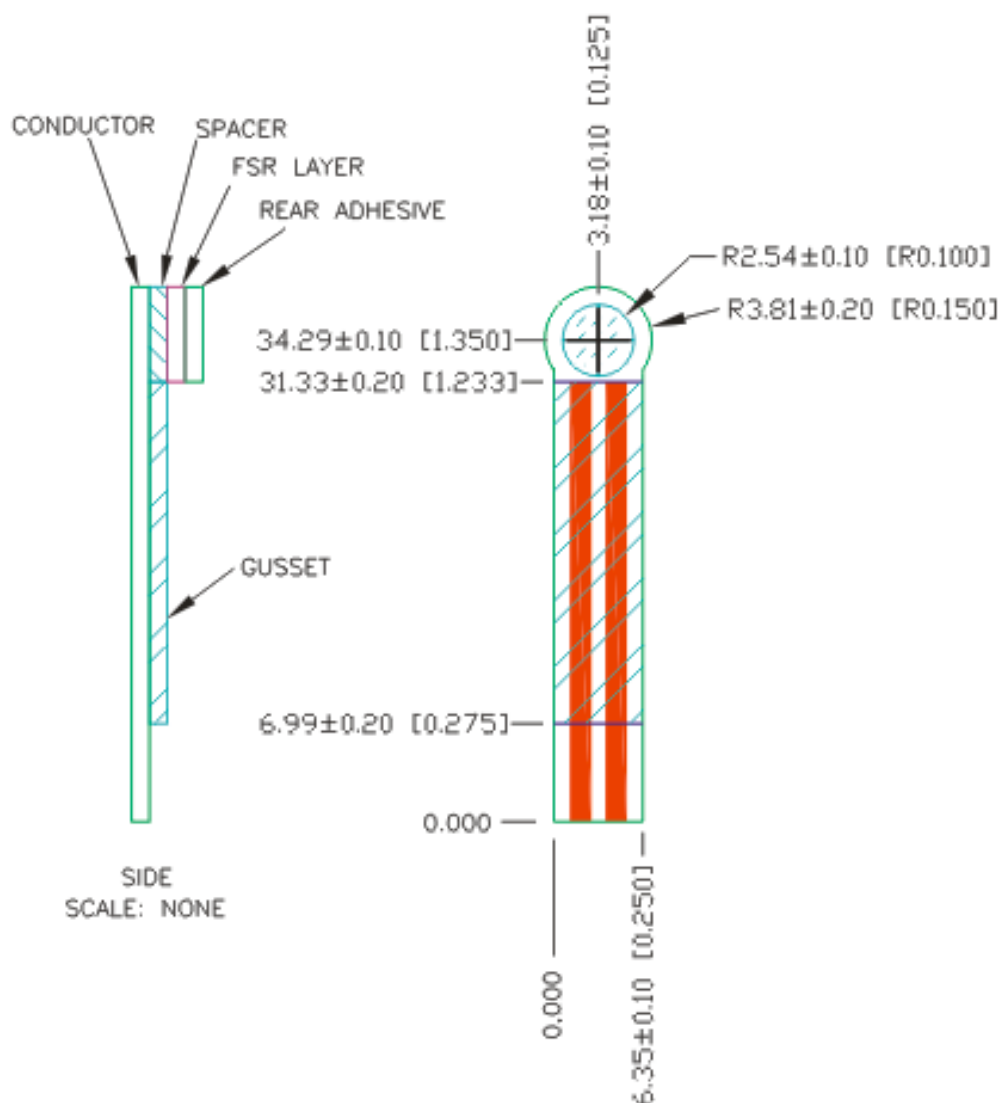
Figure 5: Model 400 Round FSR

Measurements: millimeters [inches]
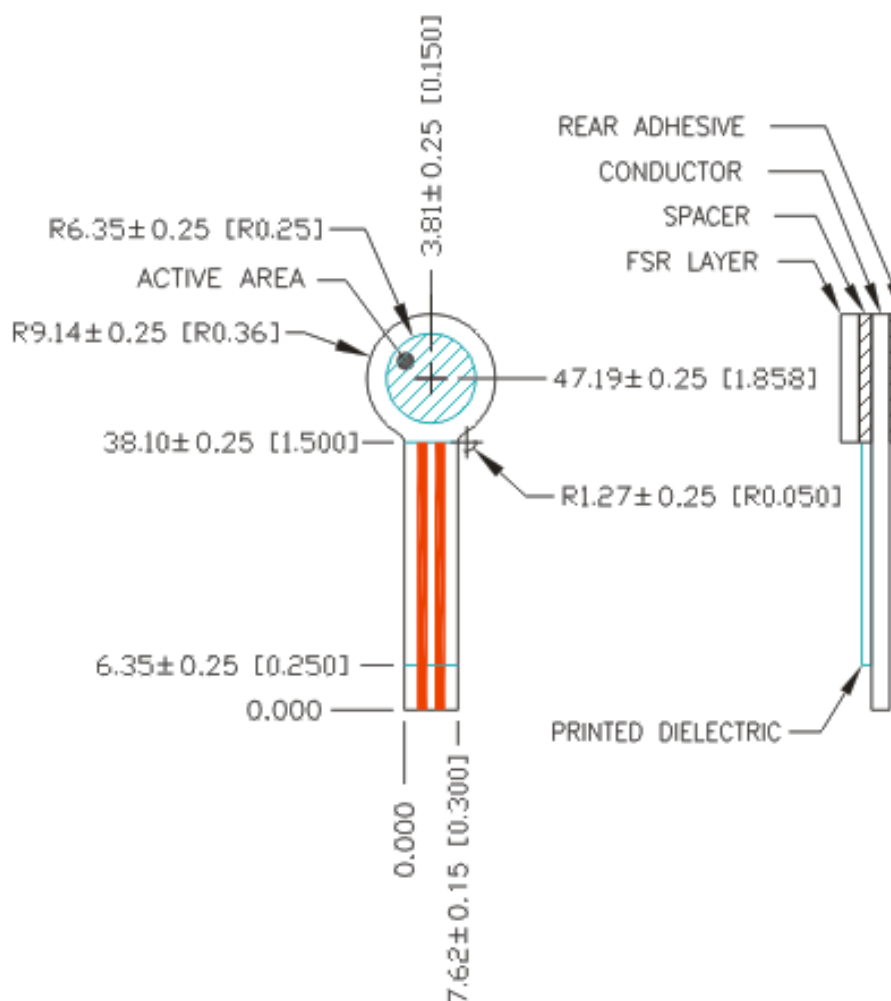
Figure 6: Model 402 Round FSR

Square

The standard Model 406 (Figure 7) square FSR, as compared to the round FSR, offers similar functionality within a larger electrically active area.

Measurements: millimeters [inches]
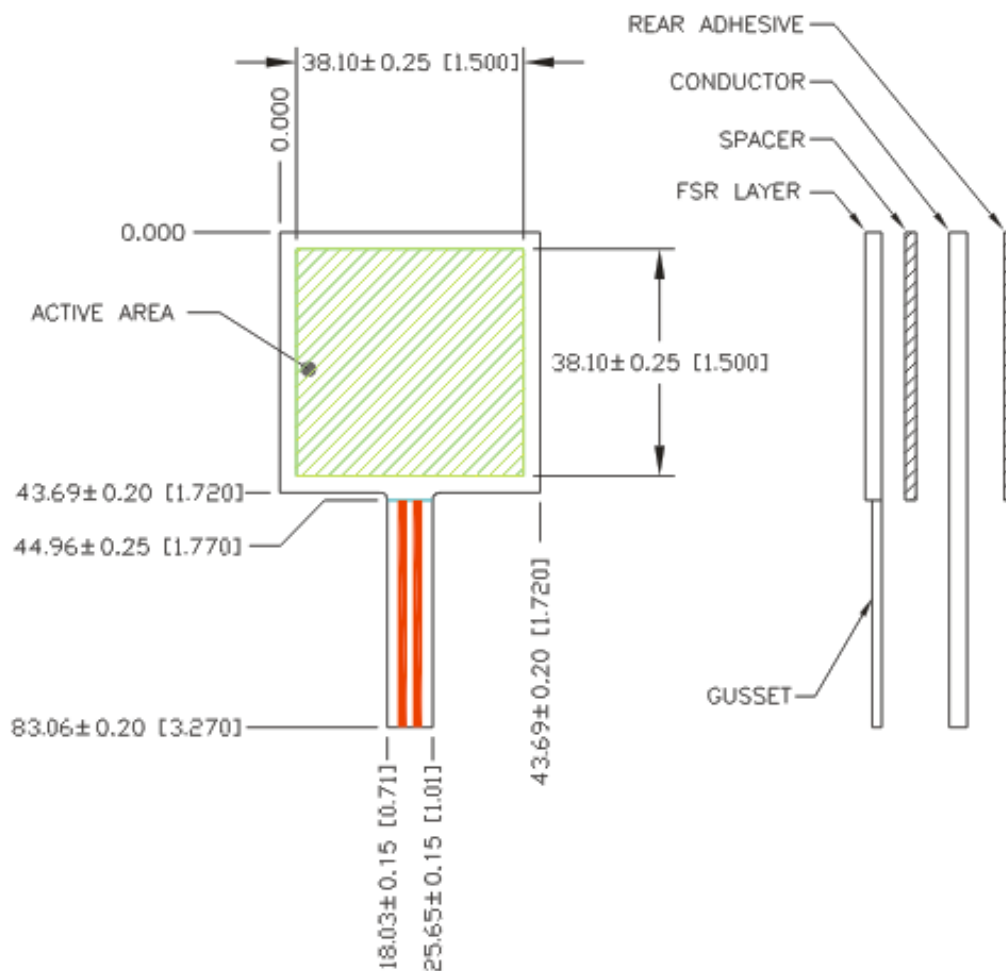
Figure 7: Model 406 Square FSR

Strip

The standard Model 408 (Figure 8) strip FSR is useful for force detection in large devices.

Measurements: millimeters [inches]
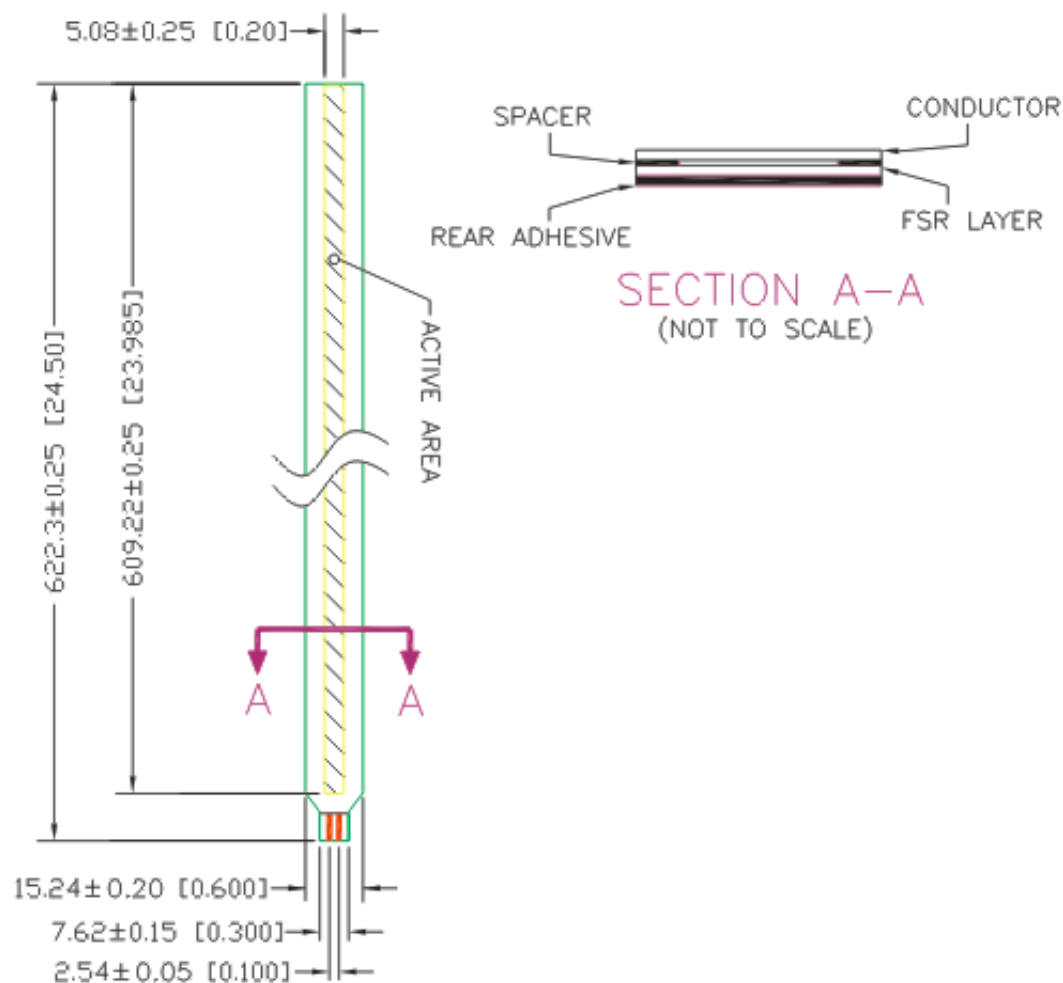
Figure 8: Model 408 Strip

Custom Sensors

Custom sensors offer flexibility in meeting the needs of unique customer design requirements. All sensors are applicable.

Below are some of the typical customization options available. Contact your Interlink representative for additional details, custom sensor examples, and to learn more about the Custom Design Process.

Shapes and Sizes

Interlink custom sensors come in a variety of shapes, sizes, and zone quantities.

Graphic Overlays and Actuators

Incorporation of a protective graphic overlay is a design option to be considered for enhanced aesthetic and durability requirements. A decorative graphic can be screen printed on the inner surface of the overlay.

Material Options

While Interlink is capable of incorporating a broad range of materials, our sensors generally rely on the following core materials – PET, FPC, FR4, various textured polyester films and adhesives.

Connection Methods

A wide range of connection options are available from flex tail and board to board connectors to direct solder & overmold and even conductive adhesives.

4.0 Performance Specifications

Below are typical parameters. The FSR is a custom device and can be made for use outside these characteristics. Consult us your specific requirements.

General

PARAMETER	VALUE	NOTES
Force Sensitivity Range	10 g to 1.0 kg (0.1 to 10N)	Dependent on mechanics
Break Force (Activation Force)	10 g (0.1N)	Dependent on mechanics and FSR build
Part-to-Part Force Repeatability	± 6% of established nominal	With a repeatable actuation system
Single Part Force Repeatability	± 2% of initial reading	With a repeatable actuation system
Hysteresis	+ 10% Average	$(R_{F+} - R_{F-})/R_{F+}$
Long Term Drift	< 5% per $\log_{10}$(time)	Tested to 35 days, 1kg load
Force Resolution	Continuous	Depends on measurement electronics
Stand-Off Resistance	> 10MΩ	Unloaded, unbent
Switch Travel	0.05mm	Typical; depends on design
Device Rise Time	<3 microseconds	Measured with drop of steel ball
Maximum Current	5 mA/cm^2 of applied force	
EMI / ESD	Generates no EMI; not ESD sensitive	

Specifications are derived from measurements taken at 1000 grams, and are given as (one standard deviation / mean), unless otherwise noted.

Environmental Performance Specifications

PARAMETER	TYPICAL R CHANGE	NOTES
Hot Operation	-15%	85°C after 1 hour
Cold Operation	-5%	-40ºC after 1 hour soak
Hot Humid Operation	+10%	+85°C, 95% RH, after 1hour
Hot or Cold Storage	-10%	-25ºC to +85°C, 120hrs
Hot Humid Storage Temperature	+ 30% of established nominal resistance	+85°C, 95% RH, 240 hours
Thermal Shock	± 2% typical	-25ºC to +70°C, 10 Cycles, 15 minute dwell, 5 minute transitions

Note: Specifications are derived from measurements taken at 1000 grams.

Durability Performance Specifications

PARAMETER	TYPICAL R CHANGE	NOTES
Tap Testing	-10%	10 million actuations, 1kg, 4Hz
Constant Load	-5%	2.5 kg standing load, 24 hrs
Chemical Resistance		The following chemicals do not affect the operation when applied to the outside of the sensor: cola, coffee, isopropyl alcohol, soap solution, household cleaners. No others tested. Application is a single drop on the exterior of the sensor that is allowed to soak until evaporation and does not enter the sensor.
Sensitivity to Noise/Vibration	No effect	

Note: Specification derived from measurements taken at 1000 grams.

5.0 Environmental and Reliability Data

Contact your Interlink Representative for full details.

6.0 Measurement Techniques

6.1 Circuit

Voltage Divider

Figure 9: FSR Voltage Divider
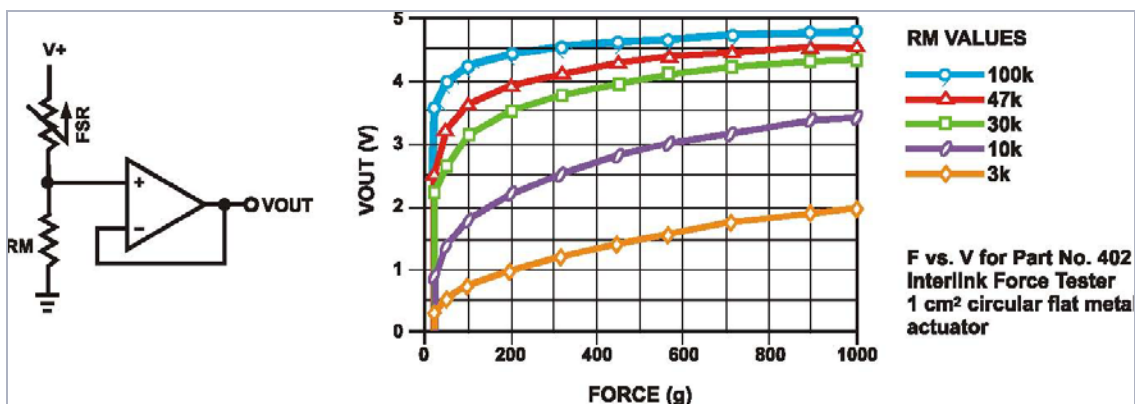
FSR Voltage Divider

For a simple force-to-voltage conversion, the FSR device is tied to a measuring resistor in a voltage divider configuration. The output is described by the equation:

$$V_{OUT} = \frac{R_M V+}{(R_M + R_{FSR})}$$

In the shown configuration, the output voltage increases with increasing force. If R_{FSR} and R_M are swapped, the output swing will decrease with increasing force.

The measuring resistor, R_M, is chosen to maximize the desired force sensitivity range and to limit current. Depending on the impedance requirements of the upstream measuring circuit (for example the ADC of a microcontroller), the op-amp voltage follower may be required.

A family of Force vs. V_{OUT} curves is shown on the graph above for a standard FSR in a voltage divider configuration with various R_M resistors. A (V+) of +5V was used for these examples.

Multi-Channel FSR-to-Digital Interface

Figure 12: Multi-Channel FSR-to-Digital Interface
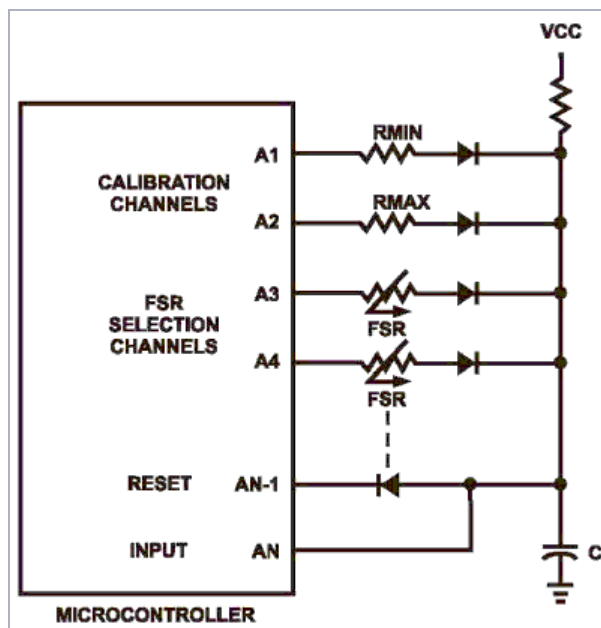
Sampling Cycle (any FSR channel):

The microcontroller switches to a specific FSR channel, toggling it high, while all other FSR channels are toggled low. The RESET channel is toggled high, a counter starts and the capacitor C1 charges, with its charging rate controlled by the resistance of the FSR (t ~ RC). When the capacitor reaches the high digital threshold of the INPUT channel, the counter shuts off, the RESET is toggled low, and the capacitor discharges.

The number of "counts" it takes from the toggling of the RESET high to the toggling of the INPUT high is proportional to the resistance of the FSR. The resistors RMIN and RMAX are used to set a minimum and maximum "counts" and therefore the range of the "counts." They are also used periodically to re-calibrate the reference. A sampling cycle for RMIN is run; the number of "counts" is stored and used as a new zero. Similarly, a sampling cycle for RMAX is run and the value is stored as the maximum range (after subtracting the RMIN value). Successive FSR samplings are normalized to the new zero. The full range is "zoned" by dividing the normalized maximum "counts" by the number of desired zones. This will delineate the window size or width of each zone.

Continual sampling is done to record changes in FSR resistance due to change sin force. Each FSR is selected sequentially.

FSR Variable Force Threshold Switch

Figure 13: FSR Variable Force Threshold Switch
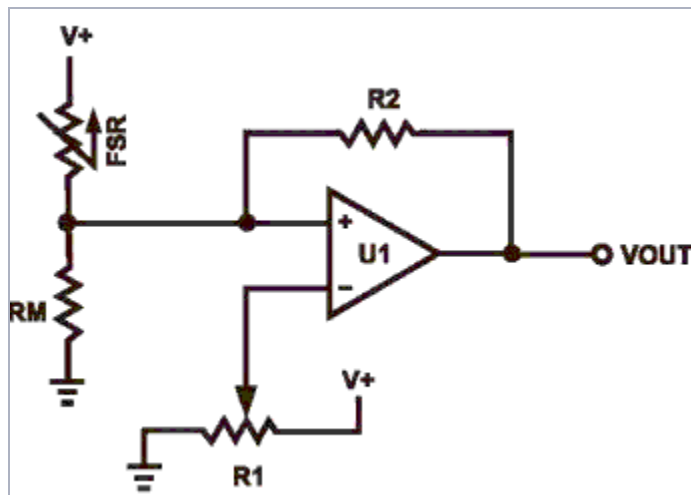
This simple circuit is ideal for applications that require on-off switching at a specified force, such as touch-sensitive membrane, cut-off, and limit switches. For a variation of this circuit that is designed to control relay switching, please see the next page.

The FSR device is arranged in a voltage divider with RM. An op-amp, U1, is used as a comparator. The output of U1 is either high or low. The non-inverting input of the op-amp is driven by the output of the divider, which is a voltage that increases with force. At zero force, the output of the op-amp will be low. When the voltage at the non-inverting input of the op-amp exceeds the voltage of the inverting input, the output of the op-amp will toggle high. The triggering voltage, and therefore the force threshold, is set at the inverting input by the pot R1. The hysteresis, R2, acts as a "debouncer," eliminating any multiple triggerings of the output that might occur.

Suggested op-amps are LM358 and LM324. Comparators like LM393 also work quite well. The parallel combination of R2 with RM is chosen to limit current and to maximize the desired force sensitivity range. A typical value for this combination is about 47kΩ.

The threshold adjustment pot, R1, can be replaced by two fixed value resistors in a voltage divider configuration.

FSR Variable Force Threshold Relay Switch

Figure 14: FSR Variable Force Threshold Relay Switch

This circuit is a derivative of the simple FSR Variable Force Threshold Switch on the previous page. It has use where the element to be switched requires higher current, like automotive and industrial control relays.
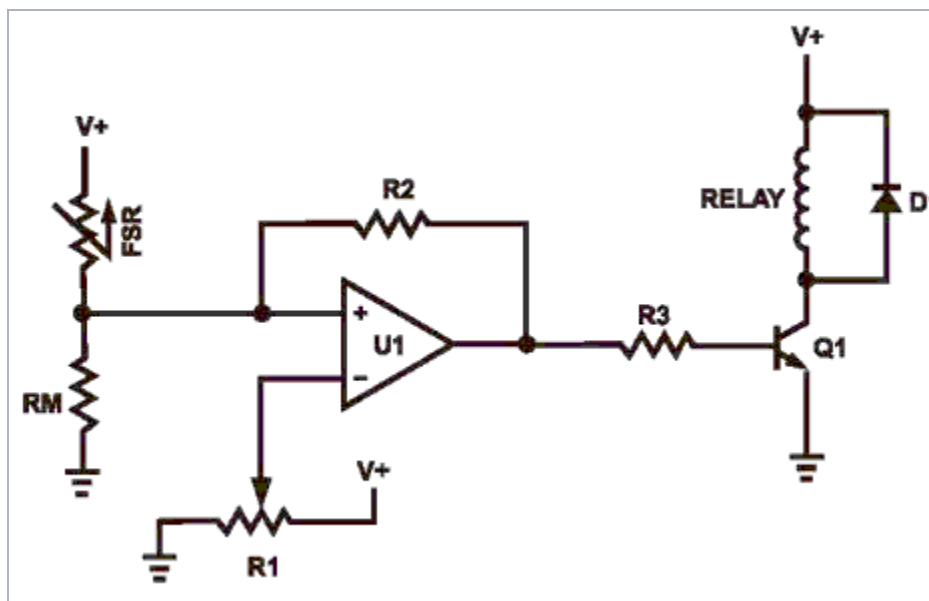
The FSR device is arranged in a voltage divider with RM. An op-amp, U1, is used as a comparator. The output of U1 is either high or low. The non-inverting input of the op-amp sees the output of the divider, which is a voltage that increases with force. At zero force, the output of the op-amp will be low. When the voltage at the non-inverting input of the op-amp exceeds the voltage of the inverting input, the output of the op-amp will toggle high. The triggering voltage, and therefore the force threshold, is set at the inverting input by the pot R1. The transistor Q1 is chosen to match the required current specification for the relay. Any medium power NPN transistor should suffice. For example, an NTE272 can sink 2 amps, and an NTE291 can sink 4 amps. The resistor R3 limits the base current (a suggested value is 4.7kΩ). The hysteresis resistor, R2, acts as a "debouncer," eliminating any multiple triggerings of the output that might occur.

Suggested op-amps are LM358 and LM324. Comparators like LM393 and LM339 also work quite well, but must be used in conjunction with a pull-up resistor. The parallel combination of R2 with RM is chosen to limit current and to maximize the desired force sensitivity range. A typical value for this combination is about 47kΩ.

The threshold adjustment pot, R1, can be replaced by two fixed value resistors in a voltage divider configuration. The diode D1 is included to prevent flyback, which could harm the relay and the circuitry.

FSR Current-to-Voltage Converter

Converter
Figure 15: FSR Current-to-Voltage

In this circuit, the FSR device is the input of a current-to-voltage converter. The output of this amplifier is described by the equation:

$$V_{OUT} = V_{REF} \cdot \left(-\frac{R_G}{R_{FSR}} \right)$$

With a positive reference voltage, the output of the op-amp must be able to swing below ground, from 0V to – VREF, therefore dual sided supplies are necessary. A negative reference voltage will yield a positive output swing, from 0V to +VREF.

$$V_{OUT} = \frac{\left(-R_G \cdot V_{REF} \right)}{R_{FSR}}$$

VOUT is inversely proportional to RFSR. Changing RG and/or VREF changes the response slope. The following is an example of the sequence used for choosing the component values and output swing:

For a human-to-machine variable control device, like a joystick, the maximum force applied to the FSR is about 1kg. Testing of a typical FSR shows that the corresponding RFSR at 1kg is about 4.6kΩ. If VREF is – 5V, and an output swing of 0V to +5V is desired, then RG should be approximately equal to this minimum RFSR. RG is set at 4.7kΩ. A full swing of 0V to +5V is thus achieved. A set of FORCE vs. VOUT curves is shown in Figure 15 for a standard FSR using this interface with a variety of RG values.

The current through the FSR device should be limited to less than 1 mA/square cm of applied force. As with the voltage divider circuit, adding a resistor in parallel with RFSR will give a definite rest voltage, which is essentially a zero-force intercept value. This can be useful when resolution at low forces is desired.

Additional FSR Current-to-Voltage Converters

Figure 16: Additional FSR Current-to-Voltage Converter

These circuits are a slightly modified version of the current-to-voltage converter detailed on the previous page. Please refer to it for more detail.

The output of Figure 16 is described by the equation:

$$V_{OUT} = R_M \left(\frac{V_{out} - V_+}{V_+} \right)$$

The output swing of this circuit is from (VREF/2) to 0V. In the case where RG is greater than RFSR, the output will go into negative saturation.

The output of Figure 17 is described by the equation:

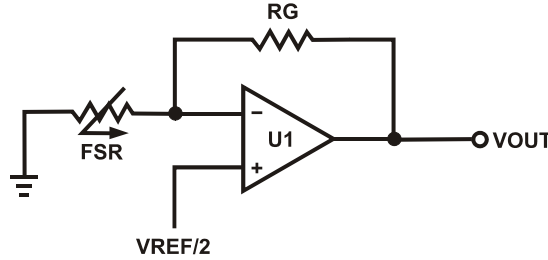$$V_{OUT} = \frac{V_{REF}}{2} \cdot \left(1 + \frac{R_G}{R_{FSR}} \right)$$

The output swing of this circuit is from (VREF/2) to VREF. In the case where RG is greater than RFSR, the output will go into positive saturation.

For either of these configurations, a zener diode placed in parallel with RG will limit the voltage built up across RG. These designs yield one-half the output swing of the previous circuit, but only require single sided supplies and positive reference voltages. Like the preceding circuit, the current through the FSR should be limited to less than 1 mA/square cm of applied force.

Suggested op-amps are LM358 and LM324.

Figure 17: Additional FSR Current-to-Voltage Converter
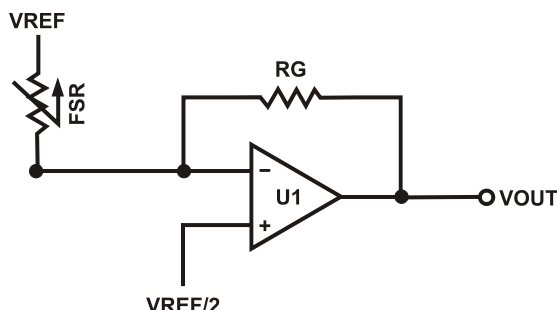
FSR Schmitt Trigger Oscillator

Figure 18: FSR Schmitt Trigger Oscillator
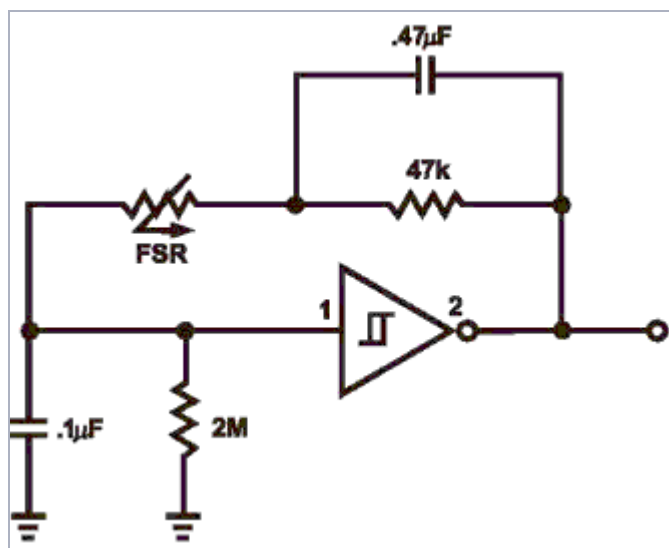
In this circuit, an oscillator is made using the FSR device as the feedback element around a Schmitt Trigger. In this manner, a simple force-to-frequency converter is made. At zero force, the FSR is an open circuit. Depending on the last stage of the trigger, the output remains constant, either high or low. When the FSR is pressed, the oscillator starts, its frequency increasing with increasing force. The 2MΩ resistor at the input of the trigger insures that the oscillator is off when FSRs with non-infinite resistance at zero force are used. The 47kΩ resistor and the 0.47 µF capacitor control the force-to-frequency characteristic. Changes in the "feel" of this circuit can be made by adjusting these values. The 0.1µF capacitor controls the frequency range of the oscillator. By implementing this circuit with CMOS or TTL, a digital process can be controlled by counting leading and/or trailing edges of the oscillator output. Suggested Schmitt Triggers are CD40106, CD4584 or 74C14.

7.0 Glossary

Terminology

Active Area: The area of an FSR device that responds to normal force with a decrease in resistance. This is typically the central area of the sensor more than 0.5mm from the inside edge of the spacer.

Actuator: An object that contacts the sensor surface and applies force to FSRs.

Applied Force: The force applied by the actuator on the sensor active area.

Array: Any grouping or matrix of FSR sensors which can be individually actuated and measured, usually all built together as a unit.

Break Force: The minimum force required, with a specific actuator size, to cause the onset of the FSR response. Typically defined as the force required to reach below 100kΩ.

Cross-talk: Measurement noise or inaccuracies of a sensor as a result of the actuation of another sensor on the same substrate. See also false triggering.

Drift: The change in resistance with time under a constant (static) load. Also called resistance drift.

Durometer: The measure of the hardness of rubber.

EMI: Electromagnetic interference.

ESD: Electrostatic discharge.

False triggering: The unwanted actuation of a FSR device from unexpected stimuli; e.g., bending or cross-talk.

Force Resolution: The smallest measurable difference in force.

FSR: Force Sensing Resistor. A polymer thick film device with exhibits a decrease in resistance with an increase in force applied normal to the device surface.

Graphic Overlay: A printed substrate that covers the FSR. Usually used for aesthetics and protection.

Housed Female: A stitched on AMP connector with a receptacle (female) ending. A black plastic housing protects the contacts. Suitable for removable ribbon cable connector and header pin attachment.

Hysteresis: In a dynamic measurement, the difference between instantaneous force measurements at a given force for an increasing load versus a decreasing load.

Repeatability: The ability to repeat, within a tolerance, a previous response characteristic.

Response Characteristic: The relationship of force or pressure vs. resistance.

Saturation Pressure: The pressure level beyond with the FSR response characteristic deviates from its inverse power law characteristic. Past the saturation pressure, increases in force yield little or no decrease in resistance.

Spacer Adhesive: The adhesive used to laminate FSR devices tighter. Dictates stand-off.

Stand-off: The gap or distance between the opposed polymer film layers when the sensor in unloaded and unbent.

Stand-off Resistance: The FSR resistance when the device is unloaded and unbent.

Substrate: Any base material on which the FSR semi-conductive or metallic polymers are printed. (For example, polyetherimide, polyethersulforne and polyester films).

Tail: The region where the lead out or busing system terminates. Generally, the tail ends in a connector.

8.0 FAQ

Below are answers to our most frequently asked questions:

What are some applications in which the Interlink sensors have been used?
Interlink sensors provide economical solutions and OEM tools to a variety of force measurement applications. Our sensors have been integrated into drug delivery devices, QA/QC equipment, industrial controls, sports and recreational gear, and more.

How much do the system and sensors cost?
Pricing varies and it is quoted by Interlink Electronics, or an authorized distributor.

What is your return policy?
Package must be returned unopened within 48 hours of receipt of merchandise.

How does the sensor react to force? Is the resistance constant, or is it decreasing with a constant value?
The inks in our sensors are resistive: the greater the force, the less the resistance.

How much can I overload the sensor without damaging it?
The mechanical properties of the different force range sensors are very similar. The polymer materials from which these sensors are manufactured will start to deform plastically around 6.89 newtons/square millimeter (10,000 pounds/square inch).

What is the lifetime of a Interlink sensor?
The durability of the Interlink sensor depends on the conditions to which it is exposed: magnitude of the load, the interface material, and the direction of the load (minimal shear). The sensor is typically operational beyond 1,000,000 hits.

What materials/conditions could damage the sensor?
Temperatures >215.55°C (420°F), water-submersion (as the adhesive holding the top & bottom layers together would likely separate), sharp objects, shear forces, creasing the sensor, and loads that are around or above 6.89 newtons/square millimeter (10,000 pounds/square inch) can damage the sensor.

Can I fold the sensor?
The sensor is designed to be flexible; however the sensing area should not be folded as this causes shearing. The traces should not be bent more than 90° as the silver conductive leads could break.

Can I adhere the sensor to a surface?
If you need to adhere the sensor to a surface, a thin, double-sided tape is recommended. Often the sensors are supplied with such a rear adhesive, covered with a removable liner.

What surface is best to use underneath the sensor?
A flat, smooth surface is ideal. Trapped air bubbles or dirt particles can cause the sensor to appear loaded in the absence of an external load.

What drive voltages can I apply to the sensor?
Electrically the sensors look like passive resistors. Any voltage that suits your circuit is fine. From 0.1V (as long as signal-to-noise (S/N) ratio remains acceptable) to 5V is the typical range.

What is the resistance range of the sensor?
The resistance range of the sensor is typically from >1MΩ at no load to approximately 1kΩ at full load. This can vary depending on the details of the sensor and actuating mechanics.

How long must the sensor be unloaded before you load it again?
There is no exact or estimated time.

Are the Interlink sensors waterproof?
No, the sensors are not designed for use under water. The FSR material is not compatible with direct liquid contact. Sensors are ideally suited to placement behind a waterproof enclosure.

Does humidity have any effect on the sensor?
Yes, of all environmental extremes humidity causes the most change. Extreme humidity, for example 85 RH at 85C for hundreds of hours, will shift resistance dramatically upward.

Can the sensors pick up electrical noise?
FSRs are no more prone to noise pickup than a passive resistor, although they can have considerable surface area. Proximity to high intensity RF sources may require special measures.

What is the smallest active sensing area you can make?
Sensor sizes range from a minimum head dimension of 5mm (3mm active area) to a maximum of 56 x 42cm.

What is the usual turn-around time for custom designs?
From receipt of purchase order to completion of prototype, 2 - 4 weeks, depending on queue status at the time of order.

What are the minimum and maximum quantities you can do annually?
Due to the cost involved, we typically do not design custom sensors for when expected volumes are low. The maximum quantities that can be produced depend on several factors. We have produced specific sensors in volumes as high as 20M pcs per year.

What is the average cost of a custom design?
Each request is different, depending on size, complexity of design, force ranges, quantities, etc. Contact an Interlink sales agent for pricing.

9.0 Performance Optimization

For best results, follow these seven steps when beginning any new product design, proof-of-concept, technology evaluation, or first prototype implementation:

1. Start with Reasonable Expectations (Know Your Sensor)
The FSR sensor is not a strain gauge, load cell or pressure transducer. While it can be used for dynamic measurement, only qualitative results are generally obtainable. Force accuracy ranges from approximately ± 6% to ± 50% depending on the consistency of the measurement and actuation system, the repeatability tolerance held in manufacturing, and the extremes of the environment.

2. Choose the Sensor that Best Fits the Geometry of Your Application
Usually sensor size and shape are the limiting parameters in FSR integration, so any evaluation part should be chosen to fit the desired mechanical actuation system. In general, standard FSR products have a common response and only by varying actuation methods (e.g. overlays and actuator areas) or electrical interfaces can different response characteristics be achieved.

3. Set-up a Repeatable and Reproducible Mechanical Actuation System
When designing the actuation mechanics, follow these guidelines to achieve the best force repeatability:

- Provide a consistent force distribution. FSR response is very sensitive to the distribution of the applied force. In general, this precludes the use of dead weights for characterization since exact duplication of the weight location is rarely repeatable cycle-to-cycle. A consistent weight (force) distribution is more difficult to achieve than merely obtaining a consistent total applied weight (force). As long as the distribution is the same cycle-to-cycle, then repeatability will be maximized. The use of a thin elastomer between the applied force and the FSR can help absorb error from inconsistent force distributions.

- Keep the actuator area, shape, and material properties consistent. Changes in these parameters significantly alter the response of a given sensor. Any test, mock-up, or evaluation conditions should be closely matched to the final use conditions. The greater the cycle-to-cycle consistency of these parameters, the greater the device repeatability. In human interface applications where a finger is the mode of actuation, perfect control of these parameters is not generally possible. However, human perception of force is somewhat inaccurate so these applications may be more forgiving.

- Control actuator placement. In cases where the actuator is to be smaller than the FSR active area, cycle-to-cycle consistency of actuator placement is necessary. (Caution: FSR layers are held together by an adhesive that surrounds the electrically active areas. If force is applied over an area which includes the adhesive, the resulting response characteristic will be drastically altered.) In an extreme case (e.g., a large, flat, hard actuator that bridges the bordering adhesive), the adhesive can prevent FSR actuation.

▪ Keep actuation cycle time consistent. Because of the time dependence of the FSR resistance to an applied force (drift), it is important when characterizing the sensor system to assure that increasing loads (e.g. force ramps) are applied at consistent rates (cycle-to-cycle). Likewise, static force measurements must take into account FSR mechanical setting time. This time is dependent on the mechanics of actuation and the amount of force applied and is usually on the order of seconds.

4. Use the Optimal Electronic Interface

In most product designs, the critical characteristic is Force vs. Output Voltage, which is controlled by the choice of interface electronics. A variety of interface solutions are detailed in the Tech Notes section of this guide. Summarized here are some suggested circuits for common FSR applications:

▪ For FSR Pressure or Force Switches, use the simple interfaces detailed on page 21.

▪ For dynamic FSR measurements or Variable Controls, a current-to-voltage converter (see page 22) is recommended. This circuit produces an output voltage that is inversely proportional to FSR resistance. Since the FSR resistance is roughly inversely proportional to applied force, the end result is a direct proportionality between force and voltage; in other words, this circuit gives roughly linear increases in output voltage for increases in applied force. This linearization of the response optimizes the resolution and simplifies data interpretation.

5. Develop a Nominal Voltage Curve and Error Spread

When a repeatable and reproducible system has been established, data from a group of FSR parts can be collected. Test several FSR parts in the system. Record the output voltage at various pre-selected force points throughout the range of interest. Once a family of curves is obtained, a nominal force vs. output voltage curve and the total force accuracy of the system can be determined.

6. Use Part Calibration if Greater Accuracy is Required

For applications requiring the highest obtainable force accuracy, part calibration will be necessary. Two methods can be utilized: *gain and offset trimming*, and *curve fitting*.

▪ Gain and offset trimming can be used as a simple method of calibration. The reference voltage and feedback resistor of the current-to-voltage converter are adjusted for each FSR to pull their responses closer to the nominal curve.

▪ Curve fitting is the most complete calibration method. A parametric curve fit is done for the nominal curve of a set of FSR devices, and the resultant equation is stored for future use. Fit parameters are then established for each individual FSR (or sending element in an array) in the set. These parameters, along with the measured sensor resistance (or voltage), are inserted into the equation to obtain the force reading. If needed, temperature compensation can also be included in the equation.

7. Refine the System

Spurious results can normally be traced to sensor error or system error. If you have any questions, contact Interlink Electronics' Sales Engineers to discuss your system and final data.

10.0 FSR Usage: The Do's and Don'ts

- **Do** follow the seven steps of the FSR Integration Guide.
- **Do**, if possible, use a firm, flat and smooth mounting surface.
- **Do** be careful if applying FSR devices to curved surfaces. Pre-loading of the device can occur as the two opposed layers are forced into contact by the bending tension. The device will still function, but the dynamic range may be reduced and resistance drift could occur. The degree of curvature over which an FSR can be bent is a function of the size of the active area. The smaller the active area, the less effect a given curvature will have on the FSR's response.
- **Do** avoid air bubbles and contamination when laminating the FSR to any surface. Use only thin, uniform adhesives, such as Scotch   brand double-sided laminating adhesives. Cover the entire surface of the sensor.
- **Do** be careful of kinks or dents in active areas. They can cause false triggering of the sensors.
- **Do** protect the device from sharp objects. Use an overlay, such as a polycarbonate film or an elastomer, to prevent gouging of the FSR device.
- **Do** use soft rubber or a spring as part of the actuator in designs requiring some travel.
- **Do not** kink or crease the tail of the FSR device if you are bending it; this can cause breaks in the printed silver traces. The smallest suggested bend radius for the tails of evaluation parts is about 2.5 mm (0.1"]. In custom sensor designs, tails have been made that bend over radii of 0.8 mm (0.03"). Also, be careful if bending the tail near the active area. This can cause stress on the active area and may result in pre-loading and false readings.
- **Do not** block the vent. FSR devices typically have an air vent that runs from the open active area down the length of the tail and out to the atmosphere. This vent assures pressure equilibrium with the environment, as well as allowing even loading and unloading of the device. Blocking this vent could cause FSRs to respond to any actuation in a non-repeatable manner. Also note that if the device is to be used in a pressure chamber, the vented end will need to be kept vented to the outside of the chamber. This allows for the measurement of the differential pressure.
- **Do not** solder directly to the exposed silver traces. With flexible substrates, the solder joint will not hold and the substrate can easily melt and distort during the soldering. Use Interlink Electronics standard connection techniques, such as solderable tabs, housed female contacts, Z-axis conductive tapes, or ZIF (zero insertion force) style connectors.
- **Do not** use cyanoacrylate adhesives (e.g. Krazy Glue) and solder flux removing agents. These degrade the substrate and can lead to cracking.
- **Do not** apply excessive shear force. This can cause delamination of the layers.
- **Do not** exceed 1mA of current per square centimeter of applied force (actuator area). This can irreversibly damage the device.

11.0 Contact Interlink Electronics

United States
Corporate Offices
Interlink Electronics, Inc.
546 Flynn Road
Camarillo, CA 93012, USA
Phone: +1-805-484-8855
Fax: +1-805-484-9457
Web: www.interlinkelectronics.com
Sales and support: fsr@interlinkelectronics.com

Japan
Interlink Electronics Inc. Japan Office
Kannai-Keihin Bldg. 10F/1004
2-4-2 Ougi-cyo, Naka-ku
Yokohama-shi, Kanagawa-ken 231-0027
Japan
Phone: +81-45-263-6500
Fax: +81-45-263-6501
Web: www.interlinkelec.co.jp

Korea
Interlink Electronics Korea
#215 GM Town, 834-67 Yeoksam Dong
Gangnam Gu, Seoul, 135-080
Korea
Phone: +82 10 8776 1972

www.interlinkelectronics.com
546 Flynn Road, Camarillo, CA 93012 • Phone: +1-805-484-8855